Light is OSRAM



17.12.2018

Dear Customer,

please find attached our OSRAM OS PCN:

OS-PCN-2018-022-A Product update of OSRAM OSTAR Projection Cube

Important information for your attention:

Please review the **Customer approval form** at the end of the document and provide your feedback to your OSRAM OS sales partner before **22.01.2019**. *)

Your prompt reply will help OSRAM OS to assure a smooth and well executed transition. If OSRAM OS does not hear from your side by the due date, we will assume your (if you are a Distributor: and your customer's) full acceptance to this proposed change and its implementation.

OSRAM OS understands the time requirements your organization needs to approve this PCN. However, if you can provide OSRAM OS an estimated date your organization will approve this PCN, OSRAM OS can use this date to plan continued production to secure your order needs during the transition time you require to review and approve this PCN.

Your attention and response to this matter is highly appreciated.

Please direct your inquiries to your local Sales office.

*) OSRAM OS aligns with the widely-recognized JEDEC STANDARD "JESD46-C", which stipulates:

- "Customers should acknowledge receipt of the PCN within 30 days of delivery of the PCN."
- "Lack of acknowledgement of the PCN within 30 days constitutes acceptance of the change."
- "After acknowledgement, lack of additional response within the 90 day period constitutes acceptance of the change. An acceptance or concern response should be submitted to the supplier in a timely fashion, (i.e., customer should not wait to the end of the 90 day review period before responding, if the response is known before that time.)"

Subject of change:	Product update of OSRAM OSTAR Projection Cube			
Affected products:	LCG H9RN LCG H9RM			
Reason for change:	 Increased brightness demand Roll-out of 6 inch Si subcarrier technology Introduction of additional frontend production site 			
Description of change:	 Chip level: Introduction of 6 inch UX:3 on Si carrier Introduction of Kulim as additional FE production location Package level: Improved leadframe design 			
Product identification:	Date code / Laser marking			
Time schedule for PCN material	Final qualification report	available		
(after implementation	Samples available	15.01.2019		
of change):	Intended Start of delivery	01.03.2019 ^{*)} *) or earlier if released by customer and upon mutual agreement		
Time schedule for Pre-PCN material (prior to implementation	Last time order date (LTO)	**) **) expected approval date needs to be available at this time. Lead time and LTO quantity shall be mutually agreed between OSRAM OS and customer.		
of change):	Last time delivery date (LTD)	(01.12.2019) ****) ***) planned last date for delivery of products of current status		
Assessment:	No change in device footprint, function and reliability.			
Documentation:	Customer information package Qualification report			

Note:

Pre-PCN material: Products of current status, means before implementation of the changes as described in the PCN.

PCN material: Products with implementation of the changes as described in the PCN.

Customer approval form

OS-PCN-2018-022-A Product update of OSRAM OSTAR Projection Cube

Please list product(s) affected in your application(s):

Please	e check the appropriate box below:	
W	oproval: e agree with the proposed change and ccept start of the shipment upon availability PCN material	O Not relevant: Change is not relevant for products in use.
O Ch	nange cannot be accepted:	
0	We have objections:	
0	We request following Information:	
0	We request following Samples:	
0	Expected approval date:	
0	Volume requirements for Pre-PCN mater	ial:
Sender	:	
Comp	any:	
Addre	ss / Location:	
Signat	ture:	Date:
Please	e return this approval form to your Sales	partner.

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Customer information package

OS QM CQM | 17.12.2018

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OS-PCN-2018-022-A





Reason for change

- Increased brightness demand
- Roll-out of 6 inch Si subcarrier technology
- Introduction of additional frontend production site

Description of change

Chip level:

- Introduction of 6 inch UX:3 on Si carrier
- Introduction of Kulim as additional FE production location

Package level:

Improved leadframe design

No change in device footprint, function and reliability.





Description of change – chip level:

	Before PCN		After PCN		
Picture (exemplary)	Τ 50μm	1mm	Τ50μm	1mm	
Chip height	150µm		1	20µm	
Wafer diameter	100 mm (4")		150	mm (6")	
Chip carrier material	Ge		Si		
Chip Production location	Penang (Malaysia) Regensburg (Germany)		Regensb	g (Malaysia) urg (Germany) (Malaysia)	





Description of change – package level:

Improved leadframe design:

- Implementation of solder control structure (details see drawing on page 8)
- Increased leadframe metal thickness below chip

Before PCN
After PCN

Schematic drawing (cross section) of leadframe design change:

Conversion layer

Note: drawing is not to scale





List of affected products

OSRAM OSTAR Projection Cube

LCG H9RN

LCG H9RM

PCN Samples: on request





Changes in the datasheets: Updated Datasheet Versions

Product type	Data sheet version before PCN	Data sheet version after PCN
LCG H9RN	1.2	1.3
LCG H9RM	1.3	1.4

For additional information regarding the changes please refer to the next pages.

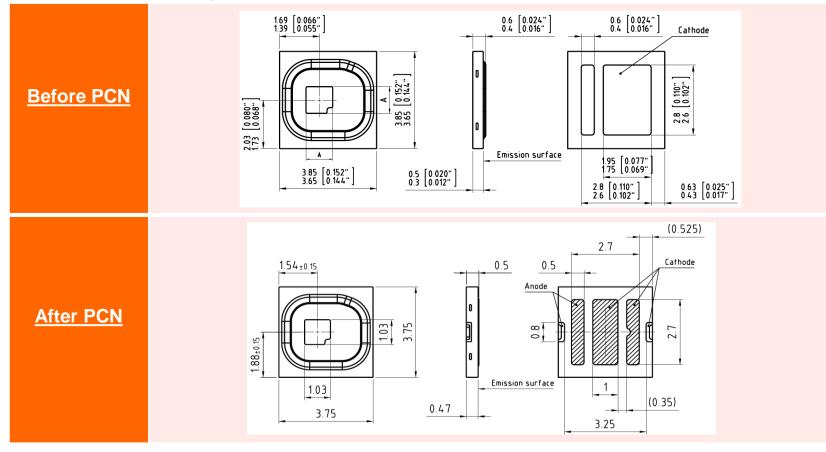
Note: After PCN approval and shipment of new material, the new data sheet versions will be valid. Latest version of data sheet is accessible on OSRAM OS homepage.





Changes in the datasheets (exemplary shown for LCG H9RN):

Leadframe drawing







Changes in the datasheets (exemplary shown for LCG H9RN):

• Updated color binning

Before PCN					After PCI	<u>\</u>
Group	Сх	Су		Group	Сх	Су
1	0.3123	0.6378		2	0.3083	0.6404
	0.3190	0.6478			0.3150	0.6504
	0.3290	0.6411			0.3250	0.6437
	0.3223	0.6311			0.3183	0.6337

Improved Rth values

	Before PC	<u>:N</u>		After PCN	l
R _{thJS real}	typ. max.	6.0 K / W 7.5 K / W	R _{thJS real}	typ. max.	5.3 K / W 6.4 K / W
R _{thJS elec.}	typ. max.	4.3 K / W 5.4 K / W	R _{thJS elec.}	typ. max.	3.8 K / W 4.6 K / W





Time schedule

for <u>PCN material</u> (after implementation of change):	Final qualification report	Available	
	Samples available	15.01.2019	
	Intended start of delivery	01.03.2019*)	
		*) or earlier if released by customer and upon mutual agreement	
for <u>Pre-PCN material</u>	Last time order date (LTO)	01.06.2019 **)	
(prior to implementation of change):		**) expected approval date needs to be available at this time. Lead time and LTO quantity shall be mutually agreed between OSRAM OS and customer.	
	Last time delivery date (LTD)	01.12.2019 ***)	
		***) planned last date for delivery of products of	

Note:

Pre-PCN material:Products of current status, means before implementation of the changes as described in the PCN.PCN material:Products with implementation of the changes as described in the PCN.

current status





Thank you.



Products Affected by Product Change Notification

Number: OS-PCN-2018-022-A Name: Product update of OSRAM OSTAR Projection Cube Release Date: 12/17/2018 Response Due Date: 1/22/2019 Implementation Date: 3/1/2019

Product	Q Number	QNumber Description	Part Number
LCG H9RM	Q65111A1779	LCG H9RM-KZLZ-1-0-350-R18-Z	LCG H9RM-KZLZ-1-Z
	Q65111A2498	LCG H9RM-LXLZ-1-0-350-R18-Z	LCG H9RM-LXLZ-1-Z
	Q65111A5031	LCG H9RM-LYLZ-1-0-350-R18-Z-SA	LCG H9RM-LYLZ-1-SA
	Q65111A6337	LCG H9RM-LXLY-1-0-350-R18-Z-PR	LCG H9RM-LXLY-1-Z-PR
LCG H9RN	Q65111A1778	LCG H9RN-MYNY-1-0-700-R18-Z	LCG H9RN-MYNY-1
	Q65111A3831	LCG H9RN-MYNX-1-0-700-R18-Z	LCG H9RN-MYNX-1-Z
	Q65111A4963	LCG H9RN-NXNY-1-0-700-R18-Z-XX	LCG H9RN-NXNY-1-XX